

Title: Liaison letter on IEEE P802.1CM TSN for Fronthaul  
From: IEEE 802.1  
For: Information  
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Dear Colleagues,

IEEE 802.1 would like to thank 3GPP RAN3 for the information on the transport requirements for the high layer split provided in liaison letter R3-173354 (<http://www.ieee802.org/1/files/public/docs2017/liaison-3GPP-RAN3-173354-0917.zip>). We take it as input to a potential amendment to 802.1CM for the higher layer split (F1).

In continuation of our dialogue on transport for fronthaul, enclosed is the latest IEEE P802.1CM draft 2.2. We would like to inform you that draft 2.2 is in Sponsor recirculation ballot, i.e., getting finalized for approval towards publication.

We would like to maintain the dialogue between our organizations.

Respectfully submitted,  
Glenn Parsons  
Chair, IEEE 802.1 WG